AS		© Co	terial Compo pyright 2005. IPC, Bannoc ternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level p	oarts, the	declarati	on encomp	asses all lo		erials for	which th	e item is an assembly ne manufacturer has leclaration.		
175	02-2 1.1	-	Web Site for Informat //www.ipc.org/IPC-1		-1752 Standa	ırd					eclaration Class * ass 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa						
Sup	plier Information																
Com	pany Name *		Company Unique ID		Unique ID Au	uthority	Respo	onse Date	<b>)</b> *	R	esponse Do	cument ID					
SEMTECH CORPORATION 00-847-9941					DUNS		2013-0	07-22									
Contact Name * Title - Contact   ROYA READER QA Customer Service Sp					Phone - Contact *			- Contac er@semte		n	Duplicate Contact -> Authorized Representative						
Authorized Representative * Title - Rep			Title - Representative QA Customer Servic	Ə	Phone - Rep	one - Representative * E			Email - Representative * rreader@semtech.com			Supplier Comments or URL for Additional Information					
	Requester Item Number Mfr Item Number				Mfr Item Name	)	Effectiv	ve Date	Version	Manufact	uring Site	Weight *	UC	M	Unit Type		
			EClamp2522P.TCT		USB Upstrea	m Port Filter and	Г		China			4.2273	mg		Each		
Ī	Alternate Recommendat	tion							Alternate Item C		omments						
Mar	nufacturing Proces	s Inf	formation														
Term	inal Plating / Grid Array M	lateri	al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	iting	Peak Proc	ess Body	y Temperat	ure Max Tim	e at Peak Terr	perature	Number	of Reflow Cycles		
Nickel/Palladium/Gold (Ni/Pd/Au) CU Al			CU Alloy	y 1			260			<b>30</b> seconds <b>3</b>							
Com	nents																

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cumption Fields							
<b>RoHS Material</b>	RoHS Material Composition Declaration Declaration Type * Detailed													
		limit of 0.1% by mass (100 thers (PBDE) and quantity	, .				ominated Biphenyls (PBB),							
chromium, polybrominate excess of an applicable of gathered the information Company will rely on this completing this form, and certifications regarding the conditions of that agreen	ed biphenyls and/or polybrominated quantity limit, please indicate below it provides in this form using approp certification in determining the com I that Supplier may not have independent rein contributions to the part, and the nent, including any warranty rights a	which, if any, RoHS exemption you b priate methods to ensure its accuracy apliance of its products with European andently verified such information. Ho pose certifications are at least as comp	icted substance") in excess believe may apply. If the p y and that such information n Union member state laws bowever, in situations where prehensive as the certification that agreement, will be the s	of the applicable quantity limit bart is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independentl on in this paragraph. If the Co ole and exclusive source of the	identified above. If a homogene- evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges to y verified information provided by mpany and the Supplier enter into a Supplier's liability and the Comp	eous material within the part cont n shall encompass all such comp f the date that Supplier complete that Supplier may have relied on y others, Supplier agrees that, at to a written agreement with response upany's remedies for issues that a	tains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that							
RoHS Declaration	n * 1 - Item(s) does not contain	RoHS restricted substances per th	he definition above			Supplier Acceptance *	Accepted							
	declared item does not cont Il applicable exemptions.	ain RoHS restricted substanc	es per the definition a	bove except for defined	RoHS exemptions, then s	select the corresponding re	esponse in the RoHS Declaration							
Declaration Si	gnature													
		C 1 1 11 C (1 1 )			· • • • • •	<b>T</b> 1: 10 11 1 4	D' i ll i							

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

		Item/SubItem			Homogeneous		Unit of			Level	Substance Category			Substance	CAS	Exempt			Tolerance		PPM
		Name			Material	weight	Measure			Levei	Substance Category			Substance	CAS			Measure	-	+	FEIWI
+I	-1	Die	+M	-м	Doped Silicon	0.1264	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		0.1264	mg		4	29,892
+I	-1	Lead frame	+M	-м	C7025	1.49631	mg	+C	-C	Supplier		+S	-S	Cu	7440-50-8		1.435	mg		;	339,46
												+S	-s	Si	7440-21-3		0.0108	mg			2,566
								+C	-C	в	Nickel (external applic	+S	-s	Nickel	7440-02-0		0.0479	mg			11,327
								+C	-C	Supplier		+S	-s	Mg	7439-95-4		0.0026	mg		1	619
			+M	-м	Ni/Pd/Au plating	0.038367	mg	+C	-C	в		+S	-s	Nickel	7440-02-0		0.0346	mg			8,184
								+C	-C	Supplier	middle plating	+S	-s	Pd	7440-05-3		0.0031	mg			744
								+C	-C	Supplier	outer plating	+S	-S	Au	7440-57-5		0.0006	mg			148
+I	-1	Bonding wire	+M	-м	Gold	0.0451	mg	+C	-C	Supplier		+S	-S	Au	7440-57-5		0.0451	mg			10,666
+I	-1	Molding compound	+M	-м	EME-G770HCD	2.46221	mg	+C	-C	Supplier		+S	-S	Silica fused	60676-86-0		2.3022	mg		ļ	544,61
												+S	-s	Epoxy resin	Proprietary		0.0739	mg			17,474
												+S	-s	Phenol resin	Proprietary		0.0739	mg			17,474
												+S	-s	C	1333-86-4		0.0123	mg			2,912
+I	-1	Die attached epoxy	+M	-м	QMI519	0.05884 <sup>-</sup>	Img	+C	-C	Supplier		+S	-s	Ag	7440-22-4		0.0471	mg			11,136
												+S	-s	palladium compound	Proprietary		0.0001	mg			21
												+S	-s	2,6-Di-tert-butyl-p-creso	128-37-0		0.000003	mg			1
												+S	-s	Hydroquinone	123-31-9		0.00000	mg			0.01
												+S	-s	Acrylate	Proprietary		0.0093	mg			2,206
												+S	-s	Bismaleimide resin	Proprietary		0.0018	mg			418
												+S	-s	Polymer of polybutadie	Proprietary		0.0006	mg			139